

April 19, 1996

CRITICAL ITEMS LIST

PAGE 1

1) CIL ITEM : F200-BG-02  
2) FMEA CODE : F200-BG  
3) COMPONENT : POGO PRECHARGE SOLENOID CONTROL  
4) PART NUMBER : RE1493  
5) SYSTEM/SUBSYSTEM : CONTROLLER/F200-XX  
6) FAILURE MODE : FAILURE TO PROVIDE HOLDING CURRENT TO MAINTAIN SOLENOID ENERGIZED

7) PREPARED : SSME RELIABILITY  
8) APPROVED :  
9) DATE : 04-19-96  
10) REVISION/CHANGE : -001/0  
11) EFFECTIVITY : -05  
12) HAZARD REFERENCE : SEE LISTINGS BELOW  
13) CIBD #

ME3-01:3285

PHASE	FAILURE DESCRIPTION/EFFECT	CRITICALITY
C	<p>FAILURE TO MAINTAIN AT LEAST ONE COIL ENERGIZED RESULTS IN DE-ENERGIZING EMSO SOLENOID, ENABLING PURGE VIA VENT PORTS OF PCA PRESSURE ACTUATED VALVES. LOSS OF VEHICLE DUE TO OXIDIZER PUMP OVERSPEED AND FAILURE MAY RESULT IF FAILURE TO PROVIDE POGO POST-CHARGE HELIUM FLOW OCCURS AND IS NOT DETECTED.</p> <p>REDUNDANCY SCREENS: CONTROLLER SYSTEM: LIKE REDUNDANCY</p> <p>A: PASS. REDUNDANT HARDWARE ITEMS ARE CAPABLE OF CHECKOUT DURING NORMAL GROUND TURNAROUND. B: PASS. LOSS OF A REDUNDANT HARDWARE ITEM IS DETECTABLE DURING FLIGHT. C: PASS. LOSS OF REDUNDANT HARDWARE ITEMS COULD NOT RESULT FROM A SINGLE CREDIBLE EVENT.</p>	IR HAZARD REF: NE-C1A,C

F-131

CEL ITEM: F200-BG-02

## DESIGN

## DOCUMENT REF.

ALL CAUSES: OUTPUT ELECTRONICS: SOLENOID VALVE DRIVEN OR FALSE COMMAND PROCESSED TO DRIVER (1)

DUAL REDUNDANT COIL DRIVERS ARE PROVIDED FOR EACH SOLENOID VALVE (1). A FAILURE IN BOTH CONTROLLER CHANNELS (MULTIPLE FAILURE), RESULTING IN LOSS OF HOLDING CURRENT TO A SOLENOID COIL, RESULTS IN DE-ENERGIZING OF THE ENSO SOLENOID, ENABLING PURGE VIA VENT PORTS OF THE PRESSURE ACTUATED VALVES (2). THE CONTROLLER (WITH SOFTWARE) IS CONFIGURED TO DETECT AND RESPOND PROPERLY TO OUT OF QUALIFICATION LIMIT FAILURES, IMPLEMENT THE APPROPRIATE REDUNDANCY MANAGEMENT RESPONSE, AND COMMAND A SAFE ENGINE STATE WHEN CONTROLLER REDUNDANCY IS LOST (2). HOWEVER, THE CONTROLLER (WITH SOFTWARE) IS NOT CAPABLE OF DETECTING OR RESPONDING TO A FAILURE WHICH RESULTS IN THE LIMITS BEING MONITORED FAILING WITHIN ENGINE REDLINE LIMITS OR WITHIN NORMAL ENGINE OPERATING CONDITIONS (2).

ELECTRICAL, MECHANICAL, AND ELECTROMECHANICAL PARTS FOR THE CIRCUITS INVOLVED IN THIS FUNCTION HAVE BEEN SELECTED FROM THE CLASS S OR EQUIVALENT APPROVED PARTS SELECTION LIST (1), QUALITY ASSURANCE AND SCREENING REQUIREMENTS FOR HIGH RELIABILITY MICROCIRCUITS (2), AND THE SPECIFICATION CONTROL DRAWING FOR MICROCIRCUITS, MONOLITHIC SILICON, AND TRANSISTOR-TRANSISTOR LOGIC (TTL) FAMILY OF DEVICES (3). PRIOR TO INSTALLATION ON THE CARD ASSEMBLIES, COMPONENTS ARE SUBJECTED TO A BURN-IN PERIOD WHERE PARTS ARE EXERCISED AT TEMPERATURES IN EXCESS OF NORMAL CONTROLLER OPERATING ENVIRONMENT, BUT LESS THAN COMPONENT MAXIMUM SPECIFIED OPERATING ENVIRONMENT, TO SCREEN FOR INFANT MORTALITY (4). IN ADDITION TO THESE REQUIREMENTS, ALL COMPONENTS ARE DERATED FROM THE MAXIMUM RATING AT OPERATING EXTREMES (5). CLEANLINESS AND ALL PROCESSES USED DURING MANUFACTURE ARE CONTROLLED BY SPECIFICATION REQUIREMENTS (5).

THE CONTROLLER DESIGN MEETS ALL CEI FAIL-OPERATE/FAILSAFE REQUIREMENTS FOR THIS FAILURE MODE (1). REDUNDANT CONTROLLER CHANNEL FUNCTIONS ARE PHYSICALLY SEPARATED WITHIN THE CONTROLLER HOUSING (2). CIRCUITS ARE DESIGNED TO PREVENT BRIDGING (2), ALL EEE PARTS ARE REQUIRED TO HAVE CONFORMAL COATING, AND INTERNAL WIRING IS INSULATED TO PREVENT SHORT CIRCUITS FROM CONDUCTIVE CONTAMINATION (3). ALL ELECTRICAL COMPONENTS ARE CONTAINED WITHIN THE CASE STRUCTURE WHICH IS PRESSURIZED WITH A POSITIVE PRESSURE INERT GAS BACKFILL TO PREVENT CONTAMINATION (2). WHERE APPLICABLE, ELECTROMAGNETIC INTERFERENCE SHIELDING IS PROVIDED AND CIRCUIT INTERCONNECTS USE TWISTED PAIR WIRING (2). ALL CIRCUIT CARDS ARE KEYED TO THEIR RESPECTIVE CONNECTION LOCATIONS TO PRECLUDE IMPROPER INSTALLATION (2). RAMP CLAMPS ARE UTILIZED TO PRECLUDE VIBRATION INDUCED CARD FAILURES (2). DESIGN OF CIRCUIT CARDS AND DETERMINATION OF COPPER PATH TRACE SPACING, WEIGHT, AND WIDTH IS CONTROLLED BY SPECIFICATION (2). EACH UNIT (PRODUCTION AND RECYCLE) IS REQUIRED TO PASS A FUNCTIONAL ACCEPTANCE TEST UNDER ENVIRONMENTAL CONDITIONS BEYOND THOSE SEEN DURING NORMAL FIELD OPERATION WITHOUT DEGRADATION OF HARDWARE LIFE EXPECTANCY (2). A WORST CASE CIRCUIT ANALYSIS WAS PERFORMED TO VERIFY NOMINAL OPERATION AT SPECIFICATION LIMITS (4). AN ANALYSIS WAS PERFORMED BY HONEYWELL TO ASSURE NO SINGLE POINT COMPONENT FAILURES ARE INHERENT TO THE CONTROLLER DESIGN (5).

(1) HONEYWELL BLOCK 11  
FMEA VOL V OE-F14

(1) DSHG8977A1  
(2) CP406R0008  
3.1.3:4  
3.2.1:6.3  
3.2.3:2.3  
3.2.3:3  
3.2.3:6  
3.2.4

(1) 85M03928,  
85M03929  
(2) 85M02704  
(3) 85M03766  
(4) 85M03876  
(5) DSHG8977A1

(1) CP320R00038  
(2) DSHG8977A1  
(3) 85M03928  
(4) E924472-01  
(5) HONEYWELL BLOCK 11  
FMEA VOL I

CIL ITEM: F200-BG-02		DESIGN	DOCUMENT REF.
DESIGN QUALIFICATION TESTING OF THE CONTROLLER ASSEMBLY HAS BEEN PERFORMED INCLUDING: FAULT INSERTION TESTING (1), ASSEMBLY THERMAL CYCLING (2), CASE AND ASSEMBLY VIBRATION TESTING (3), ELECTROMAGNETIC INTERFERENCE AND SUSCEPTIBILITY TESTING (4), ACOUSTICAL NOISE TESTING (5), CASE ULTIMATE PRESSURE TESTING (6), AND ASSEMBLY BREAK OPEN INSPECTION (7).			(1) TR34079282 TR34080202 TR34080258 TR34080259 (2) TR34080203 TR34080207 (3) TR34080204 TR34080205 TR34080206 TR34087499 (4) TR34080209 (5) TR34080210 (6) TR34085021 (7) TR34085022
CIL ITEM: F200-BG-02		INSPECTION AND TEST	DOCUMENT REF.
POSSIBLE CAUSES	SIGNIFICANT CHARACTERISTICS	INSPECTION(S)/TEST(S)	DOCUMENT REF.
ALL CAUSE:	RE1493 - CONTROLLER  ASSEMBLY INTEGRITY        MATERIAL INTEGRITY	CLEANLINESS REQUIREMENTS ARE VERIFIED PER SPECIFICATION DURING MANUFACTURING OF THE CONTROLLER ASSEMBLY.  ENVIRONMENT CONTROLS (TEMPERATURE, HUMIDITY) ARE ENFORCED DURING ASSEMBLY AND TESTING PER SPECIFICATION REQUIREMENTS.  TO PREVENT COMPONENT DAMAGE, STATIC ELECTRICAL DISCHARGE POTENTIAL IS CONTROLLED DURING MANUFACTURING PER SPECIFICATION REQUIREMENTS.  MATERIAL INTEGRITY IS VERIFIED PER SPECIFICATION REQUIREMENTS.	RE1493 RC1493 DSHG8977A1 DSHG8977A1 RC1493

CIL ITEM: F200-BG-02		INSPECTION AND TEST	
POSSIBLE CAUSES	SIGNIFICANT CHARACTERISTICS	INSPECTION(S)/TEST(S)	DOCUMENT REF.
F-134	INTEGRITY OF ELECTRONICS	PROTECTIVE FINISHES AND MATERIAL SELECTION TO PREVENT DETRIMENTAL EFFECTS FROM ENVIRONMENTAL EXPOSURE, STRESS CORROSION, AND ELECTROLYTIC CORROSION ARE VERIFIED PER SPECIFICATION REQUIREMENTS.	RC1493 MSFC-SPEC-250
		FLAMMABILITY REQUIREMENTS ARE VERIFIED PER SPECIFICATION REQUIREMENTS.	RC1493
		THE FOLLOWING PROCESSES ARE VERIFIED PER SPECIFICATION DURING MANUFACTURING OF THE CARD ASSEMBLIES:	
		<ul style="list-style-type: none"> <li>- CONSTRUCTION OF PRINTED CIRCUIT BOARDS.</li> <li>- INSTALLATION OF TERMINALS.</li> <li>- PLASTICS AND ELASTOMERS FOR ELECTRONIC ENCAPSULATION.</li> <li>- SOLDERED ELECTRICAL CONNECTIONS.</li> <li>- POST-SOLDERING INSPECTION FREE OF SPLATTER AND CONTAMINATION.</li> <li>- ELECTRICAL BONDING.</li> <li>- COMPONENT LEAD AND INTERCONNECTION MATERIAL SELECTION.</li> <li>- FREE OF CONTAMINATION AFTER CONFORMAL COATING.</li> </ul>	RL10005 RL10007 RL10008 RL10009 RL10009 RC1493 BSM03928 RC1493
WELD INTEGRITY	ALL WELDS ARE VERIFIED TO DRAWING AND SPECIFICATION REQUIREMENTS.	RL10011	
PRE-CLOSEOUT TESTING AND INSPECTION	THE FOLLOWING TESTS ARE PERFORMED AT THE CARD/COMPONENT LEVEL DURING MANUFACTURING:		
	<ul style="list-style-type: none"> <li>- PARTICUL IMPACT NOISE DETECTION (PIND) TEST ON HYBRID MICROCIRCUITS AND CAVITY TYPE DEVICES.</li> <li>- ULTRASONIC SCAN TEST FOR DELAMINATION CERAMIC ON CAPACITORS (C0R05 AND C0R06).</li> <li>- BURN-IN PERIOD FOR ELECTRICAL PARTS.</li> <li>- INSULATION RESISTANCE AND CONTINUITY TEST.</li> <li>- DIELECTRIC WITHSTANDING VOLTAGE.</li> <li>- FUNCTIONAL TEST.</li> <li>- X-RAY OF CONTROLLER INTERNAL CABLES AND WIRES.</li> </ul>	DSHGB977A1 DSHGB977A1 BSM03928 DSHGB977A1 DSHGB977A1 DSHGB977A1 DSHGB977A1	

CIL ITEM: F200-BG-02		INSPECTION AND TEST	
POSSIBLE CAUSES	SIGNIFICANT CHARACTERISTICS	INSPECTION(S)/TEST(S)	DOCUMENT REF.
		<p>THE FOLLOWING INSPECTIONS ARE PERFORMED ON THE COMPLETED ASSEMBLY PRIOR TO FINAL CLOSURE:</p> <ul style="list-style-type: none"> <li>- INTERNAL AND EXTERNAL CLEANLINESS.</li> <li>- CARD DIMENSIONS ARE VERIFIED AT CARD ASSEMBLY.</li> <li>- CHASSIS CAVITY INSPECTION FOR CONTAMINATION.</li> <li>- ELECTRICAL INTERFACE CONNECTORS.</li> <li>- CARD INSTALLATION AND CONFIGURATION AUDIT.</li> <li>- CONFORMAL COATING OF EEE PARTS.</li> </ul>	<p>RC1493 DSHG8977A1 RC1493 RC1493 DSHG8977A1 BSM03928</p>
	ACCEPTANCE TESTS	<p>THE FOLLOWING TESTS ARE PERFORMED BY HONEYWELL DURING ACCEPTANCE TESTING:</p> <ul style="list-style-type: none"> <li>- HERMETIC SEAL AND PRESSURIZATION PORT LEAK TEST.</li> <li>- FUNCTIONAL TEST INCLUDING:                             <ul style="list-style-type: none"> <li>- OUTPUT INTERFACE,</li> <li>- CHECKOUT,</li> <li>- OPERATION,</li> <li>- CONTROLLER CHECKOUT.</li> </ul> </li> <li>- HIGH TEMPERATURE OPERATION.</li> <li>- LOW TEMPERATURE OPERATION.</li> <li>- VIBRATION TESTING.</li> <li>- FINAL FUNCTIONAL TEST.</li> </ul>	<p>RC1493 RC1493 RC1493 RC1493 RC1493 RC1493 RC1493 RC1493 RC1493</p>
	HOT FIRE ACCEPTANCE TESTING (GREEN RUN)	<p>CONTROLLER OPERATION IS VERIFIED THROUGH ENGINE HOT FIRE ACCEPTANCE TESTING.</p>	<p>RL00461</p>
	HERMETIC SEAL INTEGRITY	<p>INTERNAL PRESSURE IS MONITORED DURING CONTROLLER OPERATION.</p>	<p>OMRSD V41ANO.040</p>
	FLIGHT FLOW TESTING	<p>THE FOLLOWING TESTS ARE PERFORMED DURING FLIGHT FLOW VEHICLE PROCESSING AND AFTER ANY MAINTENANCE OR REPLACEMENT:</p> <ul style="list-style-type: none"> <li>- CONTROLLER CHECKOUT.</li> <li>- PNEUMATIC CHECKOUT.</li> <li>- FLIGHT READINESS TEST.</li> <li>- SELF-TEST.</li> </ul>	<p>OMRSD V41ANO.035 OMRSD V41ASD.020 OMRSD V41ASD.030-A CP406R0008</p>

F-135

CIL ITEM: F200-BG-02		INSPECTION AND TEST	
POSSIBLE CAUSES	SIGNIFICANT CHARACTERISTICS	INSPECTION(S)/TEST(S)	DOCUMENT REF.
	PRE-FLIGHT CHECKOUT	THE FOLLOWING TESTS ARE PERFORMED DURING LAUNCH COUNTDOWN (LAST TEST): - PRE-CRYO LOADING CHECKOUT INCLUDING CONTROLLER AND PNEUMATICS CHECKOUT. - SELF-TEST.	OMRS0 SOOFAQ.213 CP406R0008
FAILURE HISTORY: COMPREHENSIVE FAILURE HISTORY DATA IS MAINTAINED IN THE PROBLEM REPORTING DATABASE (PRMS/PRACA). REFERENCE: NASA LETTER SA21/88/30B AND ROCKETDYNE LETTER 88RC09761.			

OPERATIONAL USE: NOT APPLICABLE.